

3.2x2.4mm SMD CHIP LED LAMP



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Part Number: KPBD-3224SURKZGC

Hyper Red Green

Features

- 3.2x2.4mm SMT LED, 2.4mm thickness.
- Low power consumption.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package: 1500pcs / reel.
- Moisture sensitivity level : level 3.
- · RoHS compliant.

Description

The Hyper Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

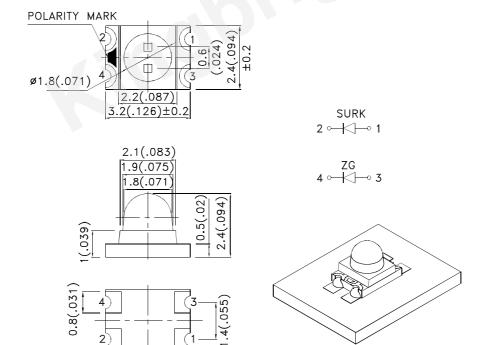
The Green source color devices are made with InGaN on Sapphire Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.004") unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
KPBD-3224SURKZGC	Hyper Red (AlGaInP)	Water Clear	700	1300	- 20°
			*120	*400	
	Green (InGaN)		500	950	
			*500	*950	

Notes:

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Green	645 515		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red Green	630 525		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Green	28 30		nm	IF=20mA
С	Capacitance	Hyper Red Green	35 45		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red Green	1.95 3.3	2.5 4.1	V	IF=20mA
lr	Reverse Current	Hyper Red Green		10 50	uA	VR = 5V

Notes:

- Navelength: +/-1nm.
 Forward Voltage: +/-0.1V.
 Wavelength value is traceable to the CIE127-2007 compliant national standards.

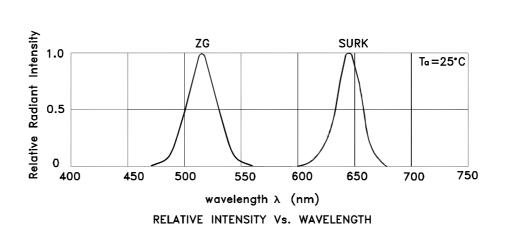
Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red	Green	Units		
Power dissipation	75	102.5	mW		
DC Forward Current	30	25	mA		
Peak Forward Current [1]	185	150	mA		
Reverse Voltage	,	V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

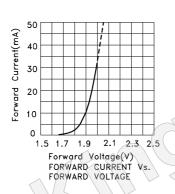
Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

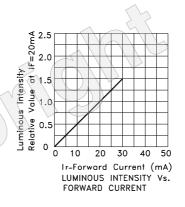
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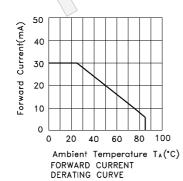
^{*}Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

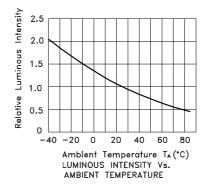


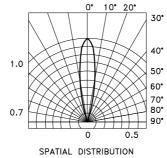
KPBD-3224SURKZGC Hyper Red





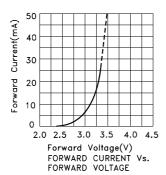


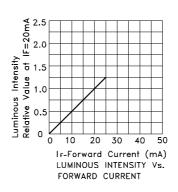


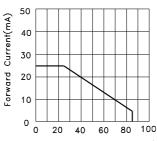


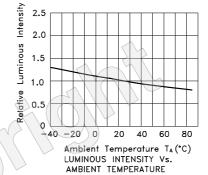
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Green

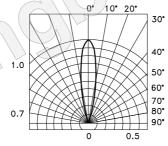












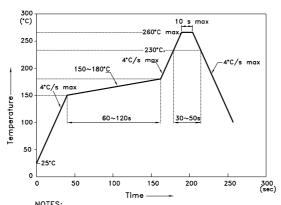
SPATIAL DISTRIBUTION

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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



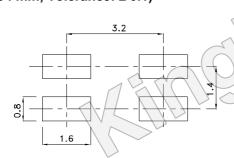
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.

 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 - to high temperature.

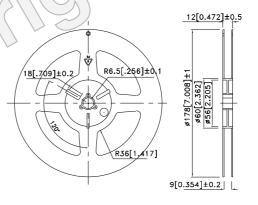
 3.Number of reflow process shall be 2 times or less.

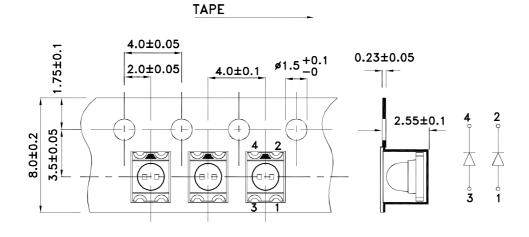
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Tape Dimensions (Units: mm)

Reel Dimension

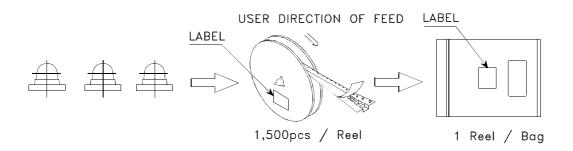


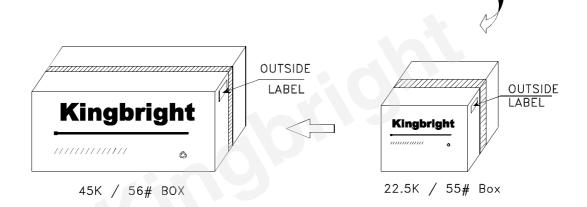


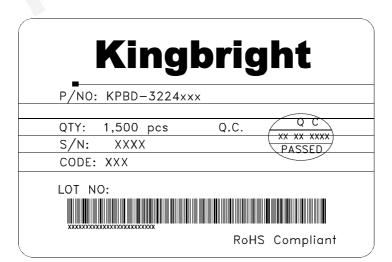
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PACKING & LABEL SPECIFICATIONS

KPBD-3224SURKZGC







Detailed application notes are listed on our website. http://www.kingbright.com/application_notes

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